

LENNTECH

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INDUSTRIAL ALL NATURAL POLYPROPYLENE CARTRIDGE HOUSINGS



All Natural Polypropylene Cartridge Housings help maintain high standards of purity and performance required in critical contamination control systems and processes.

FEATURES/BENEFITS

All Natural polypropylene components; no fillers, colorants, plasticizers or lubricants Economical alternative to fluoropolymer, stainless steel or PTFE housings
Ultra-smooth contact surfaces prevent bacterial adhesion and build-up
Resists deionized water and other inorganic solutions

Resists stress cracking
FKM O-rings for dependable sealing
0.75" NPT inlet and outlet threads
Compatible with most manufacturers

APPLICATIONS

Deionized and Reagent Grade Water Electronic Grade Chemicals (See Compatibility Chart) Reagent Grade Chemicals Pharmaceutical Cosmetic
Freons (TF, 113)
Electronic Etching Solutions
Magnetic Coatings (Tape, Disc or Card)
Reverse Osmosis or Ultrafiltration Final Filters

OPTIONS

Housings with plugged 1/4" NPT inlet, outlet and sump ports
Sump extension kit for 12" housing (157209)
Cartridge coupler (155003)
Cap plug kit (144457)

HOUSING SPECIFICATIONS

Housing All natural Polypropylene
Cap All natural Polypropylene

O-ring FKM
Max. Temperature 100°F

(37.8°C)

Max. Pressure 100 psi (6.9 bar)

CAUTION: Do not install where system will be exposed to direct sunlight. Protect against freezing to prevent cracking of the filter and water leakage. For additional information about chemical compatibility, call our technical support department at 800.861.8758.

MODEL	CARTRIDGE SEALING	MAXIMUM DIMENSIONS	INITIAL ΔP (PSI) @ FLOW RATE (GPM)*	
#10	DOE	12.057" x 5.07" (306mm x 129mm)	1 psi @10 gpm (0.07 bar @ 38Lpm)	
#12	222 O-ring sealing	15.07" x 5.07" (383 mm x 129 mm)	1 psi (10 gpm (0.07 bar (3 38Lpm)	
#20	DOE 222 O-ring sealing	22.34" x 5.07" (567 mm x 130 mm)	1 psi @10 gpm (0.07 bar @ 38Lpm)	

^{*} Pressure drop measured on empty housing.

CHEMICAL COMPATIBILITY

R = Resistant

C = Conditionally resistant

NR = Non-resistant

	100% POLY		PVDF		
SEMICONDUCTOR PROCESSING MATERIALS	68°F (20°C)	140°F (60°)	68°F (20°C)	140°F (60°C)	FKM
Acetic Acid 99.7% (135°F/51.7°C Max)	R	С	R	R	NR
Acetic Acid 50%	R	R	R	R	R
Acetone 99.5%	R	R	NR	NR	NR
Ammonium Fluoride 40%	R	R	R	R	R
Ammonium Hydroxide 10%	R	R	R	R	R
Hydrochloric Acid 37%	R	R	R	R	R
Hydrofluoric Acid 49%, 52%	R	R	R	R	R
Hydrogen Peroxide 50%	R	С	R	R	R
Methanol 99.9% [140°F/60°C Max]	R	R	R	R	NR
Methylene Chloride 99.8% (105°F/40.6°C Max)	R	NR	R	NR	R
Methyl Ethyl Ketone	R	С	NR	NR	NR
N-Butyl Acetate 99.0%	NR	NR	С	NR	NR
Nitric Acid 60%	R	NR	R	С	R
Phosphoric Acid 86%	R	R	R	R	R
Potassium Hydroxide 45%	R	R	R	R	NR
2-Propanol 99.5%	R	R	R	С	R
Sodium Hydroxide 50%	R	R	R	R	R
Sulfuric Acid 90%	R	R	R	R	R
Tetrachloroethylene 99.0%	NR	NR	R	R	R
Water-Deionized	R	R	R	R	R



FILTRATION & PROCESS

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